

MSKSEMI 美森科

SEMICONDUCTOR



ESD



TVS



TSS



MOV



GDT



PLED

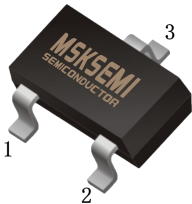
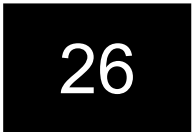
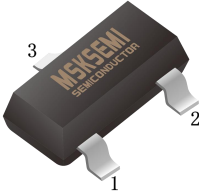
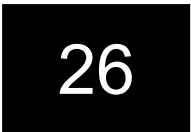
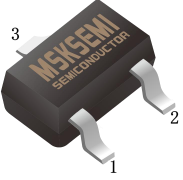
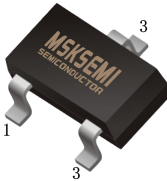
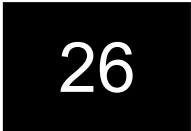
DTC144EE/EUA/EKA/ECA

Product specification

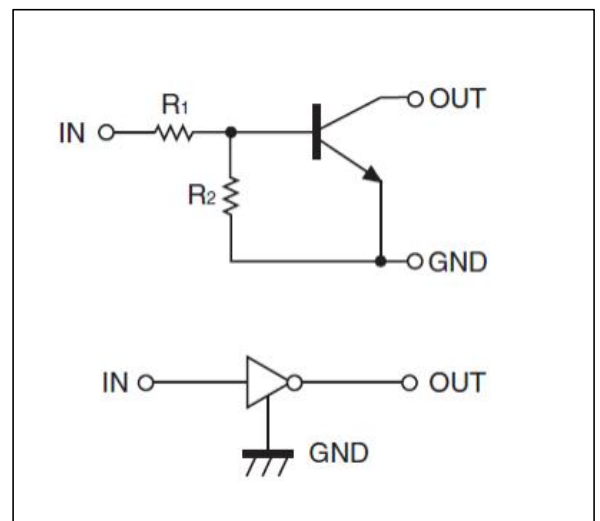
Features

- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors(see equivalent circuit)
- The bias resistors consist of thin-film resistors with complete isolation to allow negative biasing of the input.They also have the advantage of almost completely eliminating parasitic effects
- Only the on/off conditions need to be set for operation, making device design easy

Reference News

Pin Configuration	Marking
 SOT-23 1.IN 2.GND 3.OUT	
DTC144ECA	
 SOT-23-3L 1.IN 2.GND 3.OUT	
DTC144EKA	
 SOT-323 1.IN 2.GND 3.OUT	
DTC144EUA	
 SOT-523 1.IN 2.GND 3.OUT	
DTC144EE	

Equivalent Circu



MAXIMUM RATINGS (Ta=25℃ unless otherwise noted)

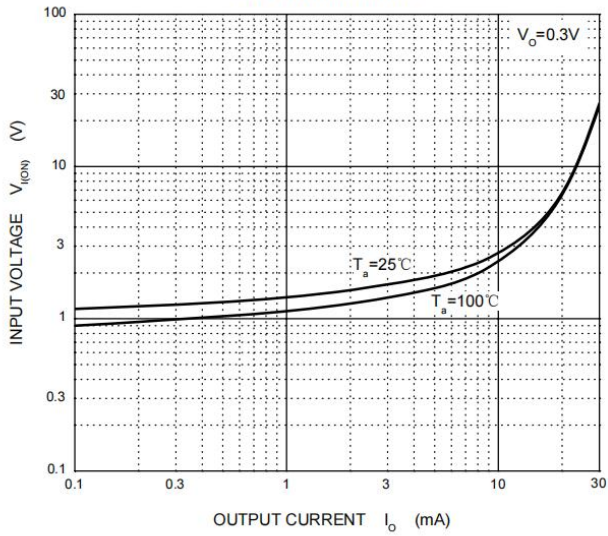
Symbol	Parameter	DTC144E				Unit
		E	UA	CA	KA	
V _{CC}	Supply Voltage	50				V
V _{IN}	Input Voltage	-10 ~ +40				V
I _O	Output Current	30				mA
I _{CM}	Peak Collector Current	100				mA
P _D	Power Dissipation	150	200	200	200	mW
T _J	Junction Temperature	150				℃
T _{stg}	Storage Temperature	-55 ~ +150				℃

ELECTRICAL CHARACTERISTICS (Ta=25℃ unless otherwise specified)

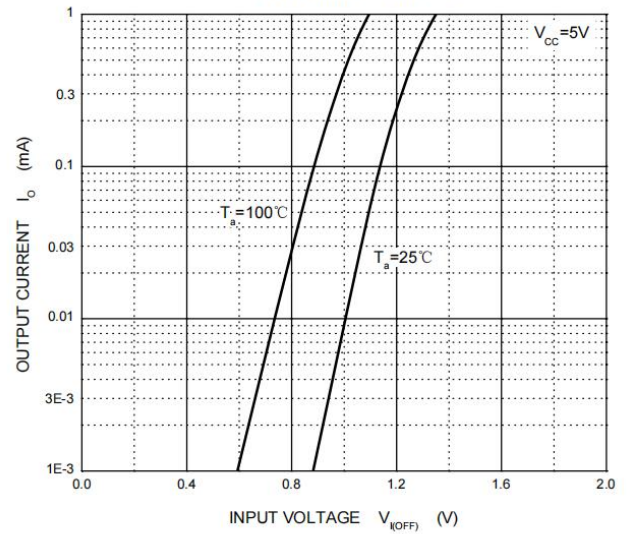
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input voltage	V _{I(off)}	V _{CC} =5V, I _O = 100μA	0.5			V
	V _{I(on)}	V _O =0.3V, I _O =2mA			3	V
Output voltage	V _{O(on)}	I _O /I _I =10mA/0.5mA			0.3	V
Input current	I _I	V _I =5V			0.18	mA
Output current	I _{O(off)}	V _{CC} =50V, V _I =0			0.5	uA
DC current gain	G _I	V _O =5V, I _O =5mA	68			
Input resistance	R ₁		32.9	47	61.1	kΩ
Resistance ratio	R ₂ /R ₁		0.8	1	1.2	
Transition frequency	f _T	V _O = 10V, I _O =5mA, f=100MHz		250		MHz

Typical Characteristics

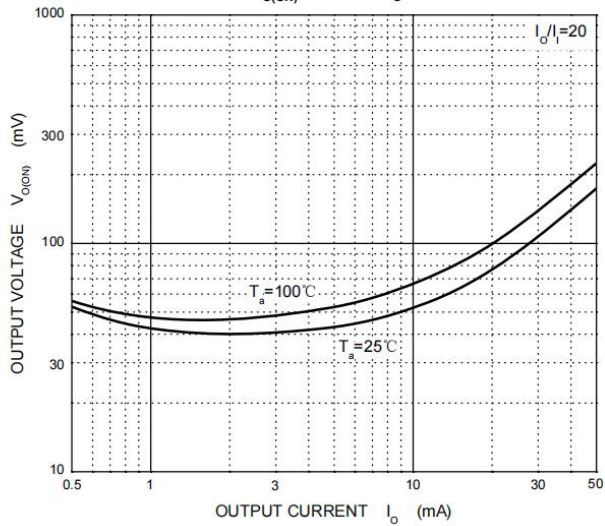
ON Characteristics



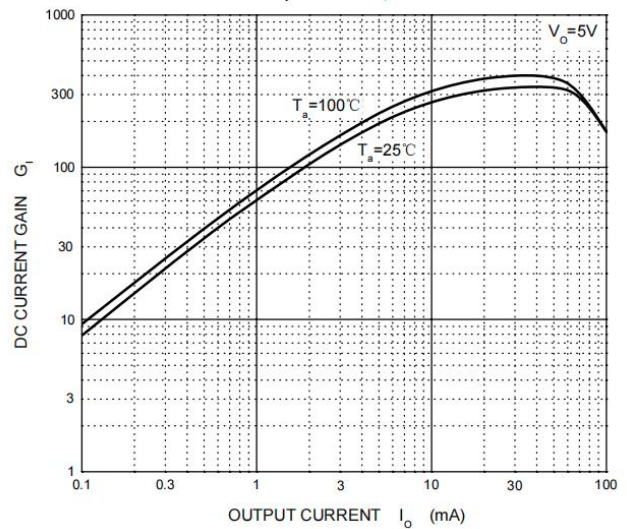
OFF Characteristics



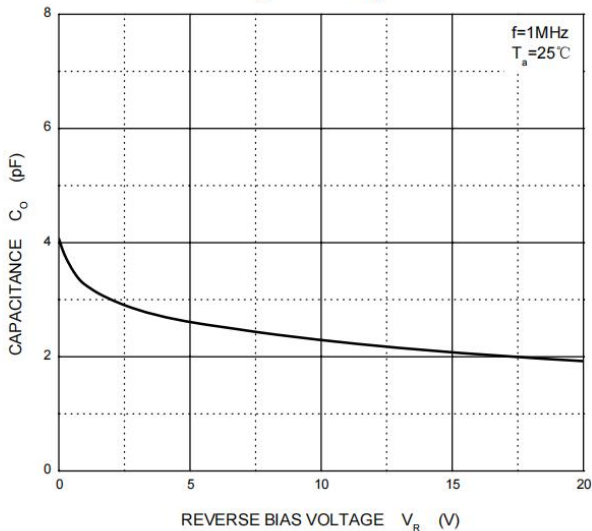
$V_{O(ON)} - I_O$



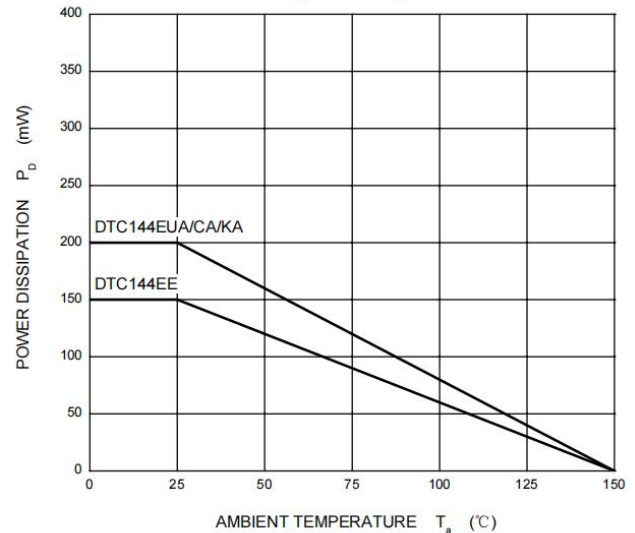
$G_I - I_O$



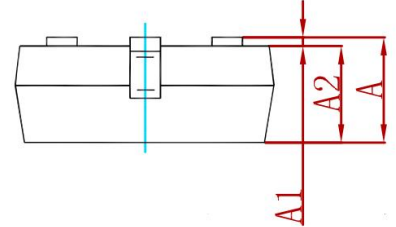
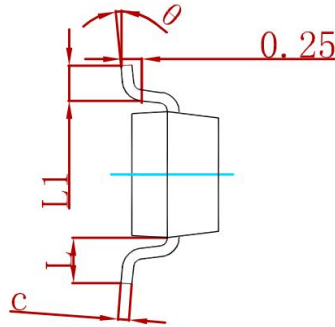
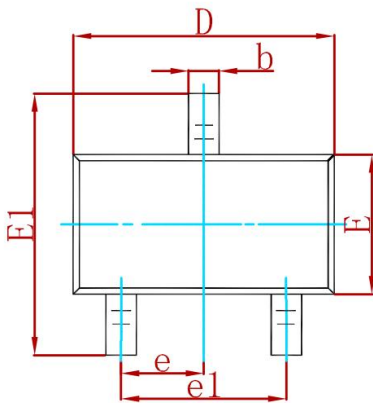
$C_O - V_R$



$P_D - T_a$

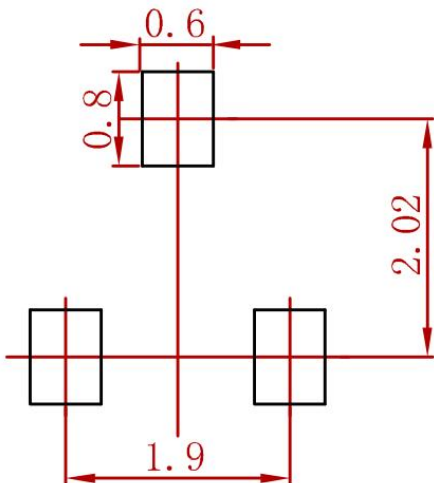


PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

Suggested Pad Layout



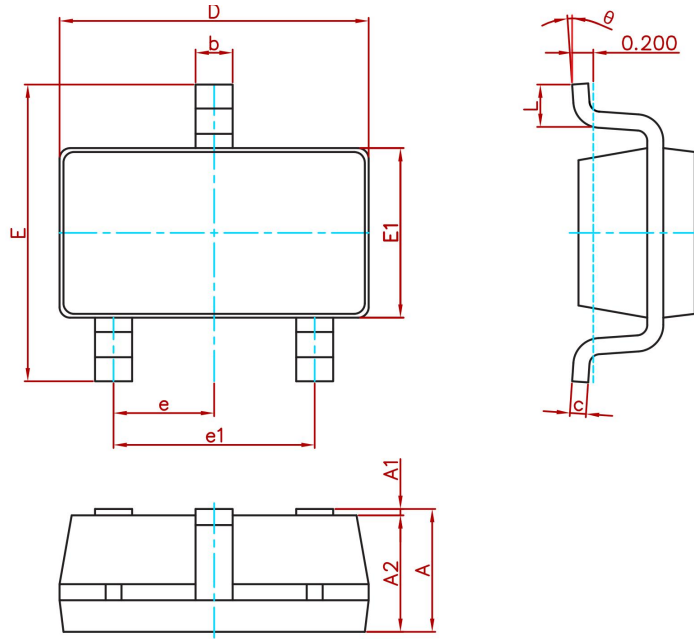
Note:

1. Controlling dimension: in millimeters.
2. General tolerance: ± 0.05 mm.
3. The pad layout is for reference purposes only.

REEL SPECIFICATION

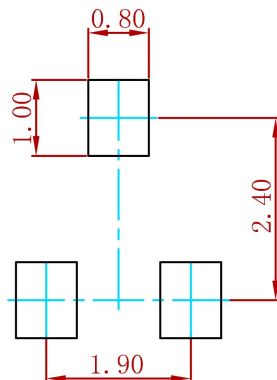
P/N	PKG	QTY
DTC144ECA	SOT-23	3000

PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.050	1.250	0.041	0.049
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.041	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E1	1.500	1.700	0.059	0.067
E	2.650	2.950	0.104	0.116
e	0.950 (BSC)		0.037 (BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
9	0°	8°	0°	8°

Suggested Pad Layout



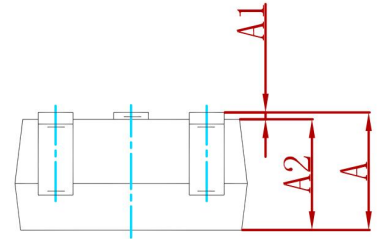
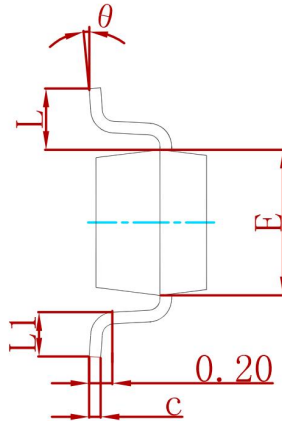
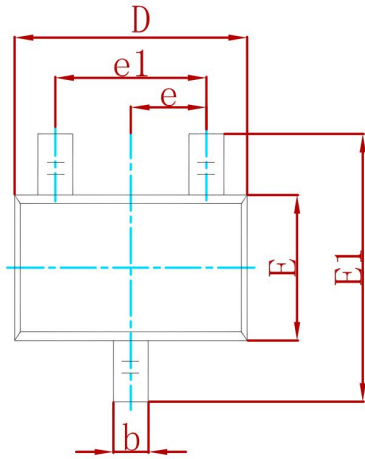
Note:

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2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

REEL SPECIFICATION

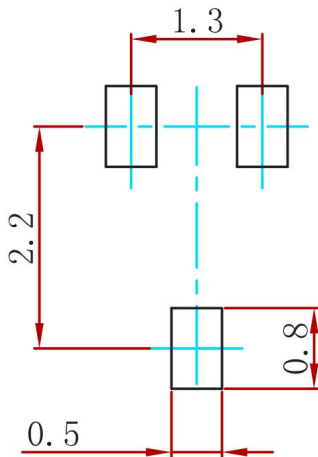
P/N	PKG	QTY
DTC144EKA	SOT-23-3L	3000

PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.200	0.400	0.008	0.016
c	0.080	0.150	0.003	0.006
D	2.000	2.200	0.079	0.087
E	1.150	1.350	0.045	0.053
E1	2.150	2.450	0.085	0.096
e	0.650 TYP		0.026 TYP	
e1	1.200	1.400	0.047	0.055
L	0.525 REF		0.021 REF	
L1	0.260	0.460	0.010	0.018
g	0°	8°	0°	8°

Suggested Pad Layout



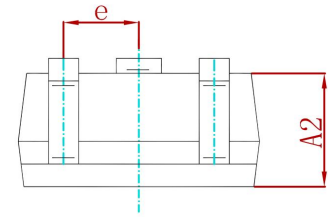
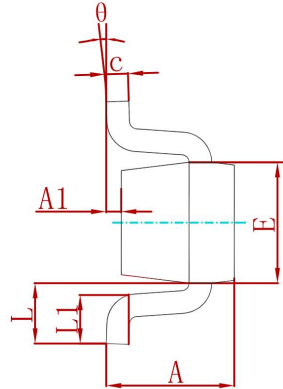
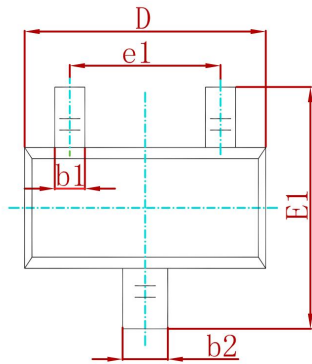
Note:

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2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.

REEL SPECIFICATION

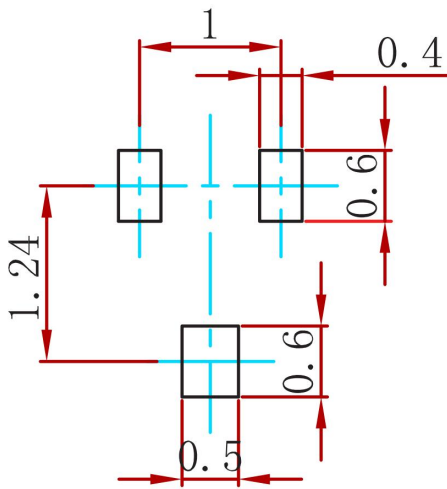
P/N	PKG	QTY
DTC144EUA	SOT-323	3000

PACKAGE MECHANICAL DATA



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.900	0.028	0.035
A1	0.000	0.100	0.000	0.004
A2	0.700	0.800	0.028	0.031
b1	0.150	0.250	0.006	0.010
b2	0.250	0.350	0.010	0.014
c	0.100	0.200	0.004	0.008
D	1.500	1.700	0.059	0.067
E	0.700	0.900	0.028	0.035
E1	1.450	1.750	0.057	0.069
e	0.500 TYP.		0.020 TYP.	
e1	0.900	1.100	0.035	0.043
L	0.400 REF.		0.016 REF.	
L1	0.260	0.460	0.010	0.018
9	0°	8°	0°	8°

Suggested Pad Layout



Note:

- Controlling dimension: in millimeters.
- General tolerance: $\pm 0.05\text{mm}$.
- The pad layout is for reference purposes only.

REEL SPECIFICATION

P/N	PKG	QTY
DTC144EE	SOT-523	3000

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